ELECTRONICS CO., LTD,

SPECIFICATION

 TITLE
 SPC. NO.
 PAGE: 1 OF 5

 DC POWER JACK
 HTJ-020-04&5
 DATE: 2004.04.23

SPECIFICATION

1. Scope

This specification applies to unified polarity type DC jack used in electronic equipment. For DC input use.

2. Standard atmospheric condition:

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient temperature : 5° C to 35° C Relative humidity : 45% to 85% Air pressure : 85kPa to 106kPa

If there is any doubt about the results, measurements shall be made within the following limits:

Ambient temperature : $20\pm1^{\circ}$ C Relative humidity : 60% to 70%

Air pressure : 86kPa to 106kPa

Operating temperature range : $-10^{\circ}\text{C} \sim 65^{\circ}\text{C}$ Storage temperature range : $-25^{\circ}\text{C} \sim 75^{\circ}\text{C}$ Humidity range : 85% RH MAX.

Operating temperature : $-10^{\circ}\text{C} \sim 65^{\circ}\text{C}$ Storage temperature : $-25^{\circ}\text{C} \sim 75^{\circ}\text{C}$

ISSUE	DATE	WRTN	CHKD	APVD	DESCRIPTIONS
<u>∕</u> 6x1	2012.06.13	黄健瑋	郭素玲	郭遠峰	Modify the item 5.1

ELECTRONICS CO., LTD,

SPECIFICATION

TITLE	SPC. NO.	PAGE:	2 OF 5
DC POWER JACK	HTJ-020-04&5	DATE:	2004.04.23

3. Electrical characteristics

	Item	Condition	Specifications	
1	Rated voltage/		DC 16V 3A	
	Rated current		DC 10 v 3/1	
		A voltage of 500V DC shall be applied for a minute.		
12	Insulation	Between conductors which should not make contact	100 M Ω MIN.	
	resistance	under normal conditions after which measurement shall	100 1/112 1/111 (.	
		be made.		
3	Contact	Measurement shall be made at with small current 1000	30 mΩ MAX.	
	resistance	Hz (1A MAX.)	30 111 22 1111 121.	
		Between conductors which should not make contact		
1	Dielectric	under normal conditions.	W/:414 di-4i4 d	
4	strength	500V AC (50 to 60Hz) for 1 minute.	Without distinct damage.	
		(Trip current 2mA)		

4. Mechanical characteristics

	Item	Condition	Specifications
		Measurement shall be made after insertion and	
1	Operating	withdrawal using standard plug gauge 3 times.	
1	force	Insertion force	2.94~29.4N (0.3~3kgf)
		Withdrawal force	2.94~29.4N (0.3~3kgf)

ELECTRONICS CO., LTD, SPECIFICATION

	ITLE	11C5 CO., L	SPC. NO.		PAGE: 3 OF 5		
DC POWER JACK				20-04&5	DATE : 2004.04.23		
	5. Endurance of						
	Item	Condition			Specifications		
		Wave soldering Process					
		wave soldering i to		A a a a a a la la v			
		Profile Feature	Topside PCB	Assembly Padside PCB	_		
		Preheat -Temperature min -Temperature max -Time (ts min to m Peak/Classification	120°C (Ts1 max)	110°C (Ts min) 150°C (Ts max) 75 sec 260°C ±5°C	Electrical and mechanical characteristics shall be satisfied, and not show remarkable		
		Temperature	(Tp1)	(Tp)	failure.		
		Time within 5°C actual Temperatus (tp)	of	10 sec (within 2 times every time 2-3 sec)			
		Time 25°C to Pe temperature		3 minutes max			
		Wave Soldering Temperature Profile are as below About the plastic properties, Please refer to the data sheet of plastic.					
]	Resistance to Soldering Heat Test		ic properties, Pleas	se refer to the dat	ta sheet of plastic.		
	Tost	Тр					
		Ts max Ts min			Tp1 max TS1 max		
		0		ts	Time		
		Topside PCB					
			Pac				
		Soldering Iron Test Temperature of sol Soldering time: 3:	dering Iron: 380±	10℃	Same as Wave soldering Process		
			Insertion force		1.96~29.4N (0.2~3kgf)		
		,	Withdrawal force		1.96~29.4N (0.2~3kgf)		

ELECTRONICS CO., LTD,

SPECIFICATION

TITLE	TLE SPC. NO.	
DC POWER JACK	HTJ-020-04&5	DATE : 2004.04.23

	Item	Cond	Specifications				
		Temperature of solder: 25	0°C±5°C	The soldered area shall be			
2	Solderability	Time of dip: 3 ± 0.5 second	ls	covered a minimum of 90% of			
		Length of dip: 2±0.5mm ((from top of terminal)	the surface being immersed.			
		The jack shall be stored at a temperature of		Electrical and mechanical			
3	Cold	-40°C±2°C for 96 hours. And then it shall be		characteristics shall be satisfied,			
3	Cold	subjected to the controlled	recovery conditions for 0.5	and not show remarkable			
		hours after which measurer	nent shall be made.	failure.			
		The jack shall be stored at a	a temperature of $70^{\circ}\text{C}\pm2^{\circ}\text{C}$	Electrical and mechanical			
4	Dryhaat	for 96 hours. And then it sh	nall be subjected to the	characteristics shall be satisfied,			
4	Dry heat	controlled recovery conditions for 1 hour after which		and not show remarkable			
		measurement shall be made	failure.				
		Temperature : 40°C±2°C					
		Relative humidity: $90\% \sim 95\%$ for 96 hours.		Electrical and mechanical			
5	Humidity test	The testing jack shall be lef	ft alone for 30 minutes in a	characteristics shall be satisfied.			
3		room ambient, before meas	surement shall be made.				
		Insulation	resistance	30MΩ MIN.			
		Contact r	esistance	50mΩ MAX.			
		Insertion and withdrawal sh	nall be made with the				
		mating plugs and jacks for	5000 cycles at a speed of				
	Ou sustinus	$10\sim30$ cycles/minute.					
6	Operating	Insertion force		29.4N MAX (3Kgf)			
	endurance	Withdray	wal force	$1.96\sim29.4N (0.2\sim3kgf)$			
		Contact register as	Between plug and contact	100mΩ MAX.			
		Contact resistance		Each closed contact	60 mΩ MAX.		

6. Warning:

Dc power jack shall be dipped, warning to inferior contact by flux and transform mold.

Resistance to flux : It shall be prevention between PCB and housing.

Transform mold : It must not add direct heat to Dc power jack

Temperature of solder : 255° C MAX. Preheat temperature : 90° C MAX. Preheat time : 2 minute MAX.

- 7. All material which are RoHS compliant by containing banned substances and all material is confirmed to be LEAD & CADMIUM FREE.
- 8. Soldering condition shelf life about 6 months depend on storage condition of humidity, temperature and others factors.

ELECTRONICS CO., LTD,

SPECIFICATION

TITLE	SPC. NO.	PAGE:	5 OF 5
DC POWER JACK	HTJ-020-04&5	DATE:	2004.04.23

9. Endurance test sequence:

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	Test sequence			С	D	Е	F
Test Ite	Test Item						
3.2	Insulation resistance	1,6		1,6	1,6	1	1,6
3.3	Contact resistance	3,8		3,8	3,8	3	3
3.4	Dielectric strength	2,7		2,7	2,7	2,6	2,7
4.1	Operating force	4		4,9	4,9	4,7	4
5.1	5.1 Resistance to Soldering Heat Test						
5.2	Solderability		1				
5.3	Cold			5			
5.4	Dry heat				5		
5.5	5.5 Humidity test					5	
5.6	5.6 Operating endurance						5

Test sample quality \div 2 pcs min. / group